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74ABT543A Octal latched transceiver with dual enable; 3-state

Rev. 5 — 3 November 2011

Product data sheet

#### **General description** 1.

The 74ABT543A high performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT543A octal registered transceiver contains two sets of D-type latches for temporary storage of data flowing in either direction. Separate latch enable (LEAB, LEBA) and output enable (OEAB, OEBA) inputs are provided for each register to permit independent control of data transfer in either direction. The outputs are guaranteed to sink 64 mA.

#### Features and benefits 2.

- Combines 74ABT245 and 74ABT373 type functions in one device
- 8-bit octal transceiver with D-type latch
- Back-to-back registers for storage
- Separate controls for data flow in each direction
- Live insertion and extraction permitted
- Output capability: +64 mA to -32 mA
- Power-up 3-state
- Power-up reset
- Latch-up protection exceeds 500 mA per JESD78B class II level A
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V

#### 3. Ordering information

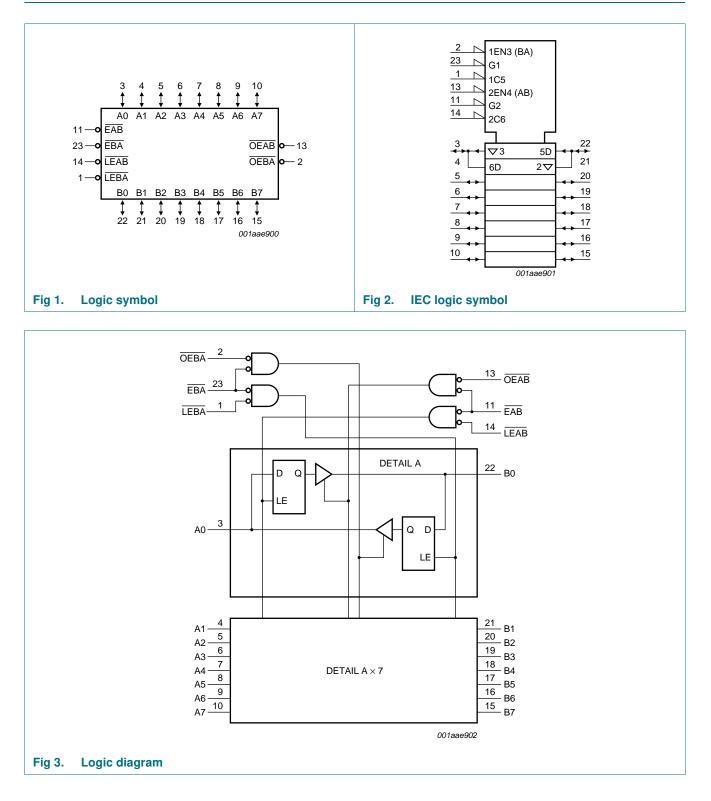
#### Table 1. **Ordering information**

Type number	Package									
	Temperature range	Name	Description	Version						
74ABT543AD	–40 °C to +85 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1						
74ABT543ADB	–40 °C to +85 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-1						
74ABT543APW	–40 °C to +85 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1						



Octal latched transceiver with dual enable; 3-state

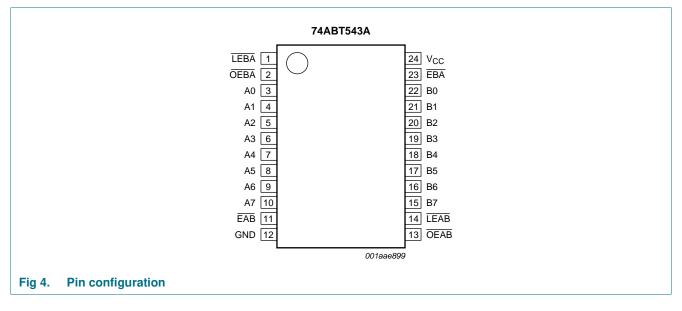
### 4. Functional diagram



Octal latched transceiver with dual enable; 3-state

### 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

### Table 2. Pin description

Symbol	Pin	Description
LEBA	1	B-to-A latch enable input (active LOW)
OEBA	2	B-to-A output enable input (active LOW)
A0 to A7	3, 4, 5, 6, 7, 8, 9, 10	data input or output
EAB	11	A-to-B enable input (active LOW)
GND	12	ground (0 V)
OEAB	13	A-to-B output enable input (active LOW)
LEAB	14	A-to-B latch enable input (active LOW)
B0 to B7	22, 21, 20, 19, 18, 17, 16, 15	data input or output
EBA	23	B-to-A enable input (active LOW)
V <sub>CC</sub>	24	positive supply voltage

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### 6. Functional description

Input				Output	Status	
OEXX	EXX	LEXX	An or Bn	Bn or An		
Н	Х	X	x	Z	disabled	
Х	Н	Х	Х	Z		
L	$\uparrow$	L	h	Z	disabled + latch	
			Ι	Z		
L	L	$\uparrow$	h	Н	latch + display	
			Ι	L		
L	L	L	Н	Н	transparent	
			L	L		
L	L	Н	Х	NC	hold	

### 6.1 Function table

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition of LEXX or EXX (XX = AB or BA);

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition of LEXX or EXX (XX = AB or BA);

 $\uparrow$  = LOW-to-HIGH clock transition of  $\overline{\text{LEXX}}$  or  $\overline{\text{EXX}}$  (XX = AB or BA);

NC = no change;

X = don't care;

Z = high-impedance OFF-state.

### 6.2 Description

The 74ABT543A contains two sets of eight D-type latches, with separate control pins for each set.

Using data flow from A-to-B as an example, when the A-to-B enable ( $\overline{EAB}$ ) input, the A-to-B latch enable ( $\overline{LEAB}$ ) input and the A-to-B output enable ( $\overline{OEAB}$ ) input are all LOW, the A-to-B path is transparent.

A subsequent LOW-to-HIGH transition of the LEAB signal puts the A data into the latches where it is stored and the B outputs no longer change with the A inputs. With EAB and OEAB both LOW, the 3-state B output buffers are active and display the data present at the outputs of the A latches.

Control of data flow from B-to-A is similar, but using the EBA, LEBA, and OEBA inputs.

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### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
VI	input voltage		<u>[1]</u> –1.2	+7.0	V
Vo	output voltage	output in OFF-state or HIGH-state	<u>[1]</u> –0.5	+5.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-18	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
lo	output current	output in LOW-state	-	128	mA
Tj	junction temperature		[2] _	150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
V <sub>CC</sub>	supply voltage		4.5	-	5.5	V	
VI	input voltage		0	-	V <sub>CC</sub>	V	
V <sub>IH</sub>	HIGH-level input voltage		2.0	-	-	V	
V <sub>IL</sub>	LOW-level input voltage		-	-	0.8	V	
I <sub>OH</sub>	HIGH-level output current		-32	-	-	mA	
I <sub>OL</sub>	LOW-level output current		-	-	64	mA	
$\Delta t / \Delta V$	input transition rise and fall rate		0	-	10	ns/V	
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C	

### 9. Static characteristics

### Table 6. Static characteristics

Symbol	Parameter	Conditions		25 °C			–40 °C to +85 °C	
				Тур	Max	Min	Max	
V <sub>IK</sub>	input clamping voltage	$V_{CC}=4.5~V;~I_{IK}=-18~mA$	-1.2	-0.9	-	-1.2	-	V
V <sub>OH</sub> HIGH-level voltage	HIGH-level output	$V_I = V_{IL} \text{ or } V_{IH}$						
	voltage	$V_{CC}$ = 4.5 V; $I_{OH}$ = -3 mA	2.5	3.2	-	2.5	-	V
		$V_{CC}=5.0~V;~I_{OH}=-3~mA$	3.0	3.7	-	3.0	-	V
		$V_{CC} = 4.5 \text{ V}; I_{OH} = -32 \text{ mA}$	2.0	2.3	-	2.0	-	V
V <sub>OL</sub>	LOW-level output voltage		-	0.3	0.55	-	0.55	V
V <sub>OL(pu)</sub>	power-up LOW-level output voltage	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 5.5 \text{ V}; \ I_O = 1 \ \text{mA}; \\ V_I = \text{GND or } V_{CC} \end{array}$	-	0.13	0.55	-	0.55	V

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Table 6.	Static characteristics	continued							
Symbol	Parameter	Conditions			25 °C		–40 °C t	o +85 °C	Unit
		_		Min	Тур	Max	Min	Max	
l <sub>l</sub>	input leakage current	$V_{CC}$ = 5.5 V; $V_I$ = GND or 5.5 V							
		OEAB, OEBA		-	±0.01	±1.0	-	±1.0	μA
		An, Bn		-	±5.0	±100	-	±100	μA
I <sub>OFF</sub>	power-off leakage current	$V_{CC}$ = 0.0 V; $V_{I}$ or $V_{O} \leq 4.5$ V		-	±5.0	±100	-	±100	μA
I <sub>O(pu/pd)</sub>	power-up/power-down output current		<u>[1]</u>	-	±5.0	±50	-	±50	μA
	OFF-state output	$V_{CC}$ = 5.5 V; $V_{I}$ = $V_{IL}$ or $V_{IH}$							
	current	V <sub>O</sub> = 2.7 V		-	5.0	50	-	50	μA
		$V_{O} = 0.5 V$		-	-5.0	-50	-	-50	μA
I <sub>LO</sub>	output leakage current	HIGH-state; $V_O = 5.5 V$ ; $V_{CC} = 5.5 V$ ; $V_I = GND$ or $V_{CC}$		-	5.0	50	-	50	μA
lo	output current	$V_{CC} = 5.5 \text{ V}; V_O = 2.5 \text{ V}$	[2]	-180	-65	-40	-180	-40	mA
I <sub>CC</sub>	supply current	$V_{CC}$ = 5.5 V; $V_{I}$ = GND or $V_{CC}$							
		outputs HIGH-state		-	110	250	-	250	μA
		outputs LOW-state		-	20	30	-	30	mA
		outputs disabled		-	110	250	-	250	μA
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC}$ = 5.5 V; one input pin at 3.4 V, other inputs at $V_{CC}$ or GND	<u>[3]</u>	-	0.3	1.5	-	1.5	mA
CI	input capacitance	$V_I = 0 V \text{ or } V_{CC}$		-	4	-	-	-	pF
C <sub>I/O</sub>	input/output capacitance	outputs disabled; $V_O$ = 0 V or $V_{CC}$		-	7	-	-	-	pF

#### Table 6. Static characteristics ... continued

[1] This parameter is valid for any V<sub>CC</sub> between 0 V and 2.1 V, with a transition time of up to 10 ms. From V<sub>CC</sub> = 2.1 V to V<sub>CC</sub> = 5 V  $\pm$  10 %, a transition time of up to 100  $\mu$ s is permitted.

[2] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[3] This is the increase in supply current for each input at 3.4 V.

### **10. Dynamic characteristics**

### Table 7. Dynamic characteristics

```
GND = 0 V; for test circuit, see Figure 10.
```

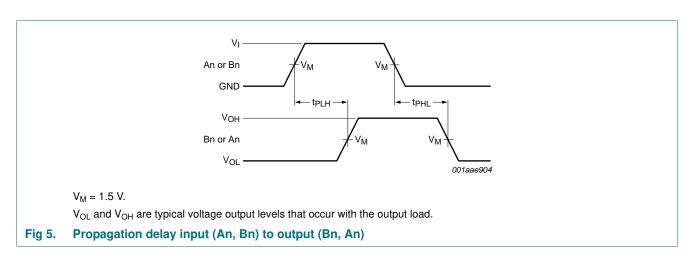
Symbol	Parameter	Conditions		25 °C; V <sub>CC</sub> = 5.0 V			_40 °C to +85 °C; V <sub>CC</sub> = 5.0 V ± 0.5 V	
			Min	Тур	Max	Min	Max	
t <sub>PLH</sub>	t <sub>PLH</sub> LOW to HIGH propagation delay	An to Bn or Bn to An; see Figure 5	1.0	2.9	4.5	1.0	5.2	ns
		LEBA to An or LEAB to Bn; see Figure 6	1.0	3.4	5.1	1.0	6.2	ns
t <sub>PHL</sub>	HIGH to LOW	An to Bn or Bn to An; see Figure 5	1.9	3.6	5.2	1.9	5.7	ns
	propagation delay	LEBA to An or LEAB to Bn; see Figure 6	2.1	4.3	6.0	2.1	6.7	ns
t <sub>PZH</sub>	OFF-state to HIGH propagation delay	OEBA to An, OEAB to Bn; see Figure 7	1.0	3.2	5.1	1.0	6.2	ns
		EBA to An, EAB to Bn; see Figure 7	1.0	3.4	5.1	1.0	6.2	ns

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Symbol Parameter		Conditions		; V <sub>CC</sub> =	5.0 V	–40 °C to +85 °C; V <sub>CC</sub> = 5.0 V ± 0.5 V		Unit
			Min	Тур	Max	Min	Max	
t <sub>PZL</sub>	OFF-state to LOW	OEBA to An, OEAB to Bn; see Figure 8	2.0	4.3	5.9	2.0	6.6	ns
	propagation delay	EBA to An, EAB to Bn; see Figure 8	2.0	4.4	6.1	2.0	6.8	ns
t <sub>PHZ</sub>	HIGH to OFF-state	OEBA to An, OEAB to Bn; see Figure 7	2.0	4.0	5.7	2.0	6.2	ns
	propagation delay	EBA to An, EAB to Bn; see Figure 7	2.0	3.6	5.4	2.0	5.9	ns
t <sub>PLZ</sub>	LOW to OFF-state propagation delay	OEBA to An, OEAB to Bn; see Figure 8	1.0	3.0	4.6	1.0	5.0	ns
		EBA to An, EAB to Bn; see Figure 8	1.0	3.0	4.6	1.0	5.0	ns
t <sub>su(H)</sub>	set-up time HIGH	An to LEAB, Bn to LEBA; see Figure 9	2.5	1.0	-	2.5	-	ns
		An to EAB, Bn to EBA; see Figure 9	3.5	1.3	-	3.5	-	ns
t <sub>su(L)</sub>	set-up time LOW	An to LEAB, Bn to LEBA; see Figure 9	3.0	1.4	-	3.0	-	ns
		An to EAB, Bn to EBA; see Figure 9	3.0	1.4	-	3.0	-	ns
t <sub>h(H)</sub>	hold time HIGH	LEAB to An, LEBA to Bn; see Figure 9	+0.5	-0.8	-	0.5	-	ns
		EAB to An, EBA to Bn; see Figure 9	+0.5	-0.8	-	0.5	-	ns
t <sub>h(L)</sub>	hold time LOW	LEAB to An, LEBA to Bn; see Figure 9	+0.5	-0.6	-	0.5	-	ns
		EAB to An, EBA to Bn; see Figure 9	+0.5	-0.6	-	0.5	-	ns
t <sub>WL</sub>	pulse width LOW	latch enable; see Figure 9	3.5	1.0	-	3.5	-	ns

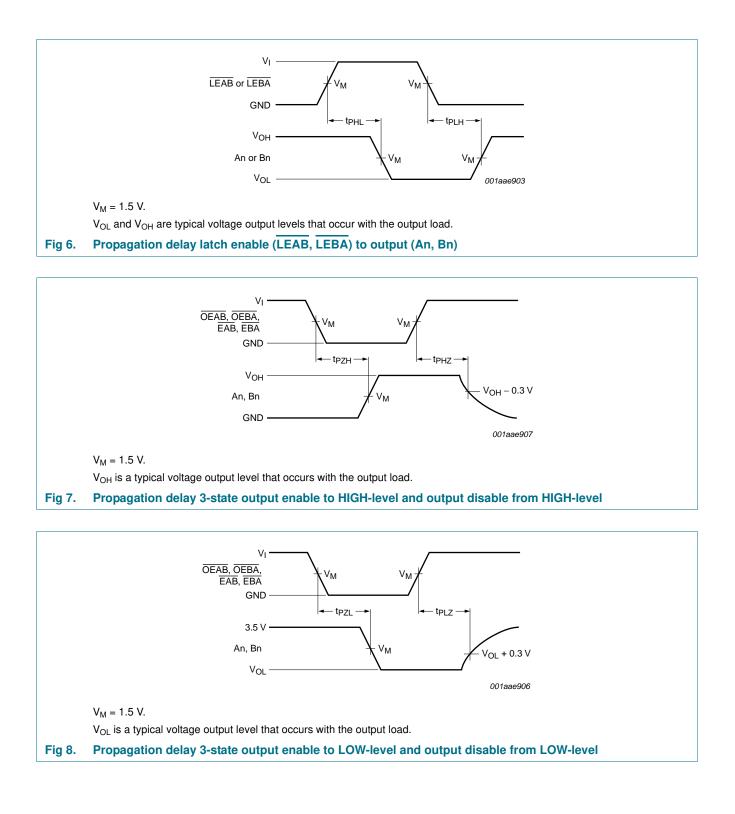
### Table 7.Dynamic characteristics ... continuedGND = 0 V; for test circuit, see Figure 10.

11. Waveforms



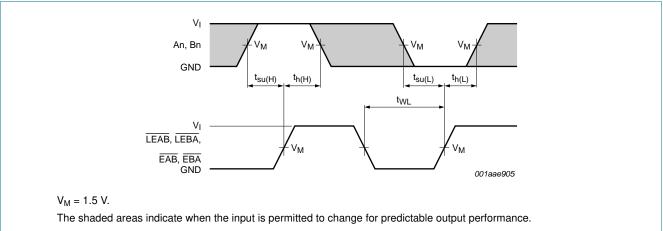
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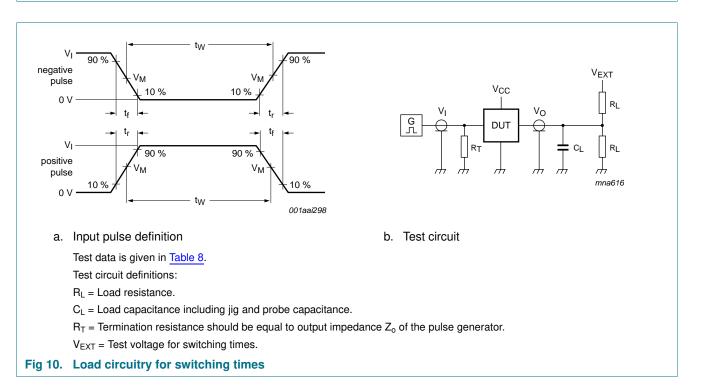


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#### Fig 9. Data set-up and hold times and latch enable pulse width



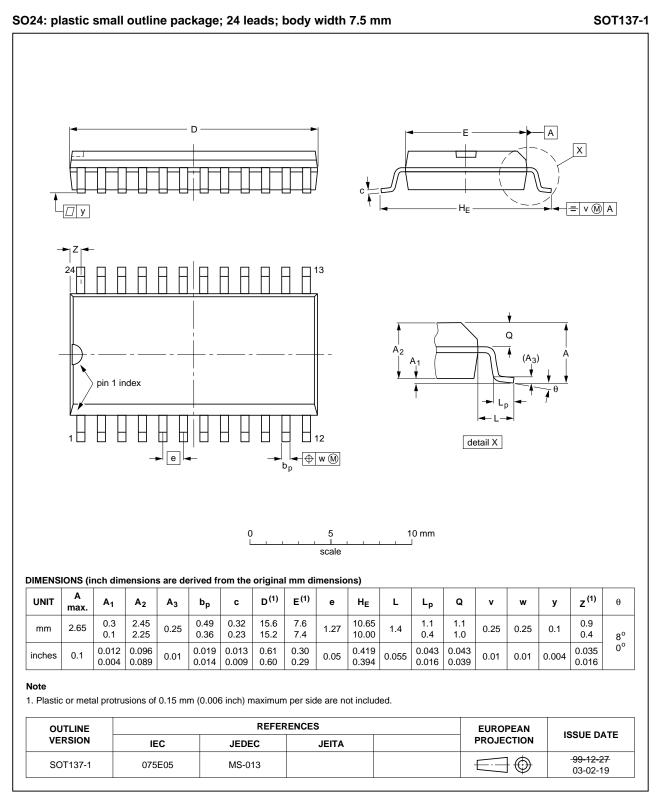
### Table 8. Test data

Input				Load		V <sub>EXT</sub>		
VI	f <sub>l</sub>	tw	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
3.0 V	1 MHz	500 ns	$\leq$ 2.5 ns	50 pF	500 Ω	open	open	7.0 V

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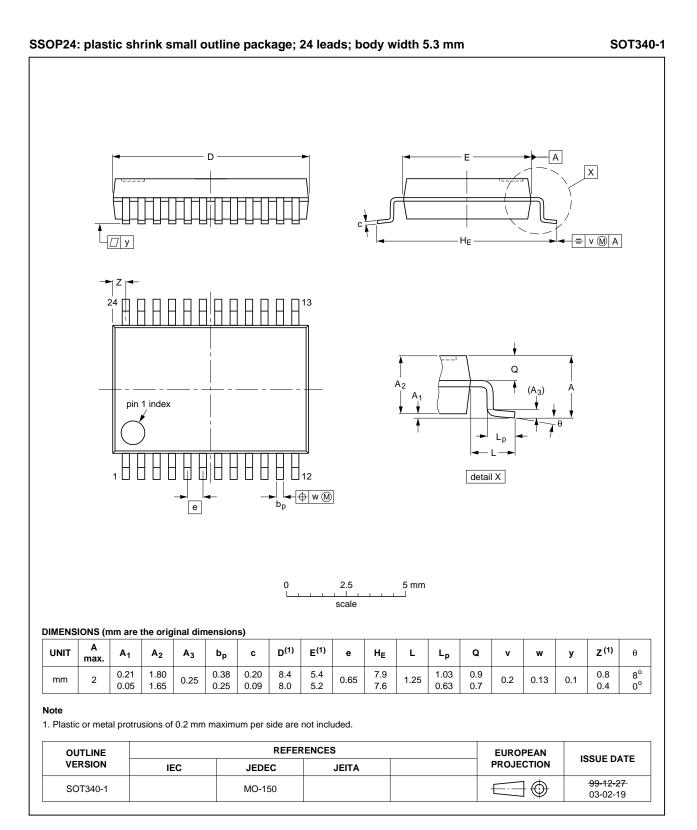
### 12. Package outline



### Fig 11. Package outline SOT137-1 (SO24)

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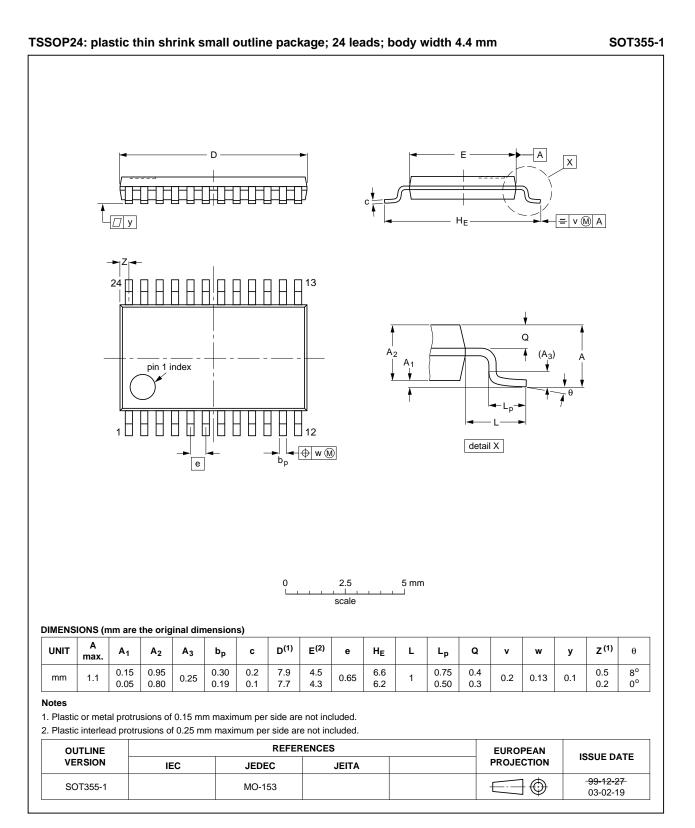
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#### Fig 12. Package outline SOT340-1 (SSOP24)

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#### Fig 13. Package outline SOT355-1 (TSSOP24)

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### **13. Abbreviations**

Table 9.	Abbreviations
Acronym	Description
BiCMOS	Bipolar Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

### 14. Revision history

### Table 10.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74ABT543A v.5	20111103	Product data sheet	-	74ABT543A v.4
Modifications:	<ul> <li>Legal page</li> </ul>	s updated		
74ABT543A v.4	20100507	Product data sheet	-	74ABT543A v.3
74ABT543A v.3	20100126	Product data sheet	-	74ABT543A v.2
74ABT543A v.2	19980924	Product specification	-	74ABT543A v.1
74ABT543A v.1	19950419	Product specification	-	-

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### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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